

RoHS

COMPLIANT

H7N1002LM-VB Datasheet N-Channel 100-V (D-S), 175 °C MOSFET

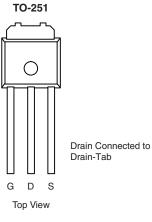
| PRODUCT SUMMARY | | | | | |
|---------------------|--|---------------------------------|-----------------------|--|--|
| V _{DS} (V) | R_{DS(on)} (Ω) | I _D (A) ^a | Q _g (Typ.) | | |
| 100 | 0.0125 at V _{GS} = 10 V | 65 | 48 nC | | |

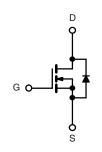
FEATURES

- Trench Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested

APPLICATIONS

- Primary Side Switch
- Isolated DC/DC Converter





N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS | T _A = 25 °C, unles | s otherwise no | oted | | |
|--|-------------------------------|-----------------------------------|------------------|------|--|
| Parameter | | Symbol | Limit | Unit | |
| Drain-Source Voltage | | V _{DS} | 100 | v | |
| Gate-Source Voltage | | V _{GS} | ± 20 | v | |
| | T _C = 25 °C | | 65 ^a | | |
| Continuous Drain Current (T_{I} = 150 °C) | T _C = 100 °C | | 52 | | |
| Continuous Drain Current $(T_j = 150^{\circ} C)$ | T _A = 25 °C | I _D | 8.2 ^b | | |
| | T _A = 100 °C | | 5.8 ^b | А | |
| Pulsed Drain Current | | I _{DM} | 200 | | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | 1 | 65 ^a | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 2.0 ^b | | |
| Single Pulse Avalanche Current | L = 0.1 mH | I _{AS} | 48 | | |
| Avalanche Energy | L = 0.1 mm | E _{AS} | 121 | mJ | |
| | T _C = 25 °C | – P _D | 156.4 | | |
| Maximum Power Dissipation | T _C = 100 °C | | 78.2 | w | |
| Maximum Fower Dissipation | T _A = 25 °C | | 3.0 ^b | ~~~~ | |
| | T _A = 100 °C | | 1.5 ^b | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^b | Steady State | R _{thJA} | 40 | 50 | °C/W | |
| Maximum Junction-to-Case | Steady State | R _{thJC} | 0.85 | 1.1 | | |

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

| SPECIFICATIONS T _J = 25 °C, unless otherwise noted | | | | | | | |
|--|-------------------------|--|------|--------|-------|-------|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | | | | 1 | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_D = 250 \mu A$ | 100 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 250 μA | | 110 | | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | 5 . | | - 12.5 | | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 2.5 | | 5 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA | |
| Zero Gate Voltage Drain Current | laaa | $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | μΑ | |
| - | IDSS | V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 125 °C | | | 50 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 50 | | | Α | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V, I _D = 15 A | | 0.0125 | | Ω | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 15 A | | 33 | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 2800 | | pF | |
| Output Capacitance | C _{oss} | V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz | | 260 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 100 | | | |
| Total Gate Charge | Qq | | | 48 | 75 | nC | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$ | | 16 | | | |
| Gate-Drain Charge | Q _{gd} | | | 13 | | 1 | |
| Gate Resistance | R _a | f = 1 MHz | | 1.6 | 2.5 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 12 | 20 | | |
| Rise Time | t _r | $V_{DD} = 50 \text{ V}, \text{ R}_{\text{I}} = 1.0 \Omega$ | | 10 | 20 | | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 50$ Å, $V_{GEN} = 10$ V, $R_g = 1 \Omega$ | | 18 | 35 | ns | |
| Fall Time | t _f | | | 8 | 15 | 1 | |
| Drain-Source Body Diode Characteris | tics | | | | | | |
| Continuous Source-Drain Diode Current | ا _S | T _C = 25 °C | | | 50 | | |
| Pulse Diode Forward Current ^a | I _{SM} | ~ | | | 100 | A | |
| Body Diode Voltage | V _{SD} | I _S = 15 A | | 0.85 | 1.5 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | , , , , , , , , , , , , , , , , , , , | | 80 | 120 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | · | | 160 | 240 | nC | |
| Reverse Recovery Fall Time | t _a | $I_F = 50 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$ | | 57 | | | |
| Reverse Recovery Rise Time | t _b | | | 23 | | ns | |

Notes:

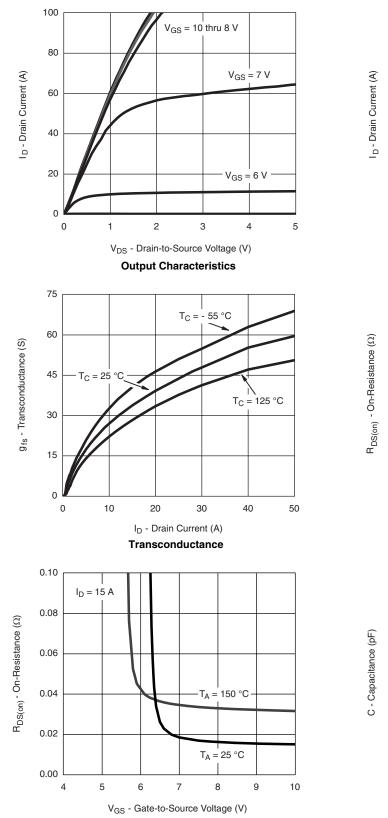
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

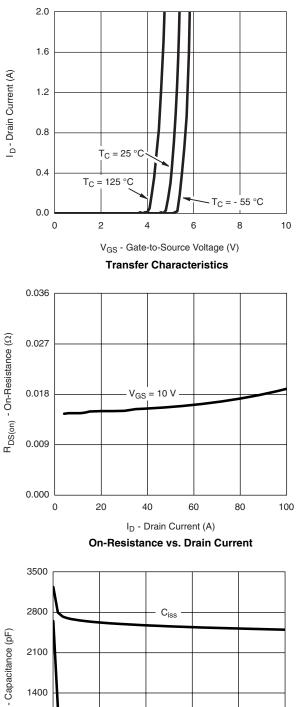
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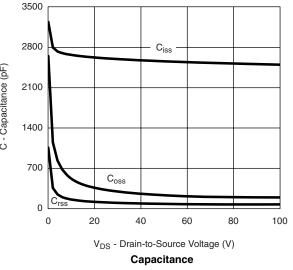
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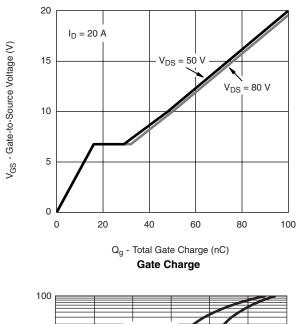


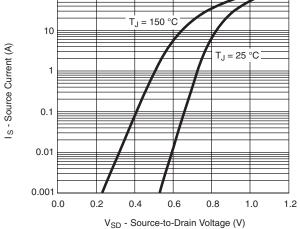




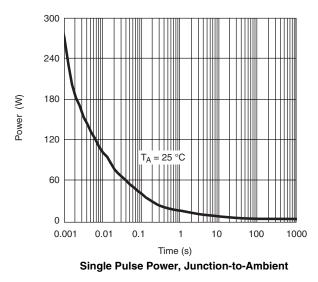


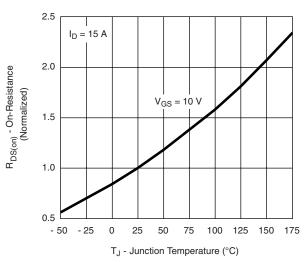




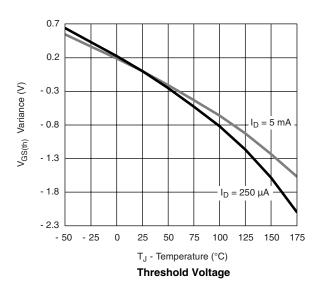


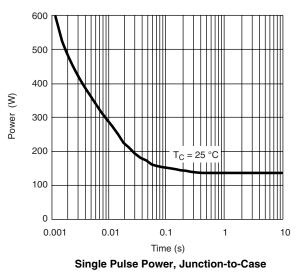




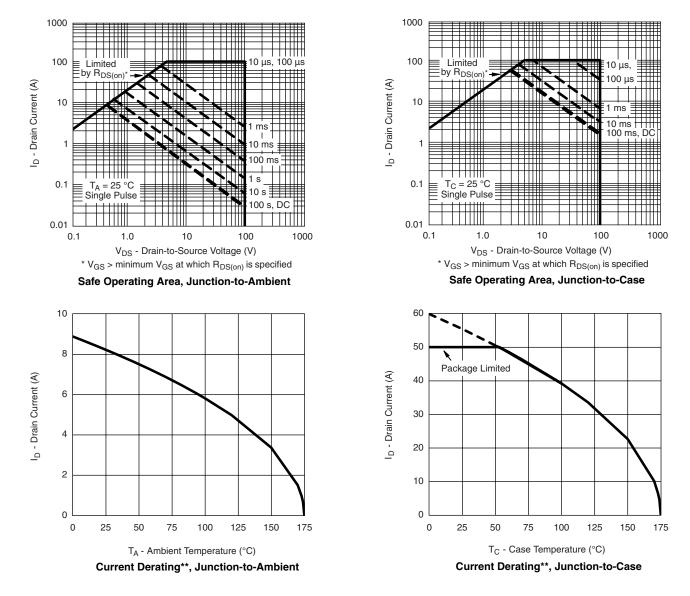


On-Resistance vs. Junction Temperature



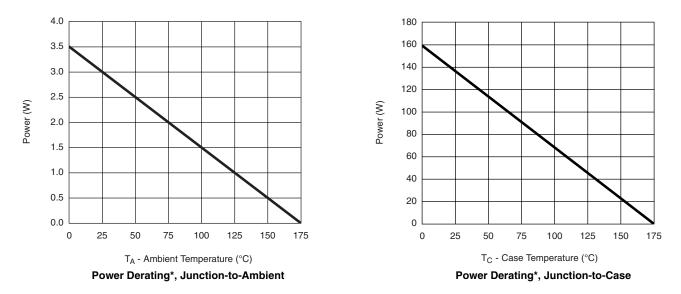






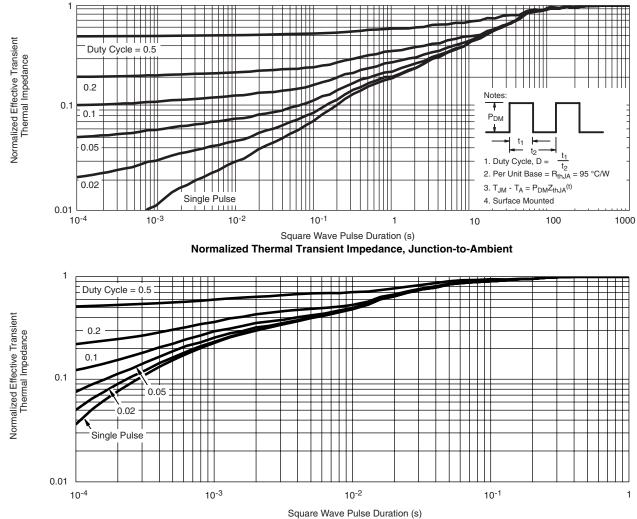
** The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





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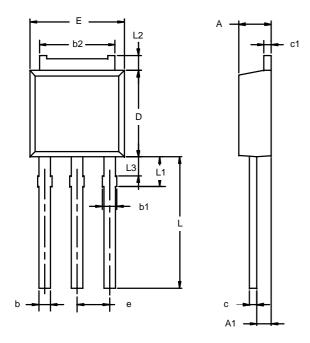




Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA (DPAK)



| | MILLIM | IETERS | INC | HES |
|-----|----------|--------|-----------|-------|
| Dim | Min | Max | Min | Max |
| Α | 2.21 | 2.38 | 0.087 | 0.094 |
| A1 | 0.89 | 1.14 | 0.035 | 0.045 |
| b | 0.71 | 0.89 | 0.028 | 0.035 |
| b1 | 0.76 | 1.14 | 0.030 | 0.045 |
| b2 | 5.23 | 5.43 | 0.206 | 0.214 |
| С | 0.46 | 0.58 | 0.018 | 0.023 |
| c1 | 0.46 | 0.58 | 0.018 | 0.023 |
| D | 5.97 | 6.22 | 0.235 | 0.245 |
| Е | 6.48 | 6.73 | 0.255 | 0.265 |
| е | 2.28 BSC | | 0.090 BSC | |
| L | 3.89 | 9.53 | 0.153 | 0.375 |
| L1 | 1.91 | 2.28 | 0.075 | 0.090 |
| L2 | 0.89 | 1.27 | 0.035 | 0.050 |
| L3 | 1.15 | 1.52 | 0.045 | 0.060 |

Note: Dimension L3 is for reference only.



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